Variant: 001

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PMP8832 REV C Bill of Materials

Item #	Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
1	!PCB	1		PMP8832	Any	Printed Circuit Board	
2	C1, C2	2	6.8uF	UCA2G6R8MPD1TD	Nichicon	CAP, AL, 6.8 μF, 400 V, +/- 20%, TH	CAPPR5-10x16
3	C3	1	470uF	16ZLJ470MTA8X11.5	Rubycon	CAP, AL, 470 μF, 16 V, +/- 20%, 0.075 ohm, TH	CAP, 8x11.5mm
4	C4	1	10uF	GRM31CR61E106KA12L	MuRata	CAP, CERM, 10 μF, 25 V, +/- 10%, X5R, 1206	1206
5	C5	1	2200pF	DE2E3KY222MA2BM01	MuRata	CAP, CERM, 2200 pF, 250 V, +/- 20%, E, Radial D8x5mm	Radial D8x5mm
6	C6	1	0.47uF	GRM21BR71H474KA88L	MuRata	CAP, CERM, 0.47 μF, 50 V, +/- 10%, X7R, 0805	0805
7	D1	1	600V	RH06-T	Diodes Inc.	Diode, Switching-Bridge, 600 V, 0.5 A, MiniDIP	MiniDIP
8	D2	1	120V	SMAJ120A	Littelfuse	Diode, TVS, Uni, 120 V, 400 W, SMA	SMA
9	D3	1	1000V	CGRM4007-G	Comchip Technology	Diode, P-N, 1000 V, 1 A, 3.9x1.7x1.8mm	3.9x1.7x1.8mm
10	D4	1	100V	B3100-13-F	Diodes Inc.	Diode, Schottky, 100 V, 3 A, SMC	SMC
11	D5	1	100V	1N4148W-TP	Micro Commercial Components	Diode, Switching, 100 V, 0.15 A, SOD-123	SOD-123
12	F1	1		RST 500	Bel Fuse	Fuse, 0.5 A, 250 V, TH	8.35x7.7x4mm
13	L100	1	22uH	VLS4012ET-220M	TDK	Inductor, Shielded, Ferrite, 22 µH, 0.63 A, 0.468 ohm, SMD	Inductor, 4x1.2x4mm
14	Q1	1	600V	AOD2N60	AOS	MOSFET, N-CH, 600 V, 2 A, DPAK	DPAK
15	R2	1	0	CRCW12060000Z0EA	Vishay-Dale	RES, 0, 5%, 0.25 W, 1206	1206
16	R3, R5	2	10.0Meg	CRCW120610M0FKEA	Vishay-Dale	RES, 10.0 M, 1%, 0.25 W, 1206	1206
17	R4	1	100	CRCW1206100RJNEA	Vishay-Dale	RES, 100, 5%, 0.25 W, 1206	1206
18	R6	1	0	CRCW04020000Z0ED	Vishay-Dale	RES, 0, 5%, 0.063 W, 0402	0402
19	R7	1	82.5k	CRCW040282K5FKED	Vishay-Dale	RES, 82.5 k, 1%, 0.063 W, 0402	0402
20	R8	1	23.7k	CRCW040223K7FKED	Vishay-Dale	RES, 23.7 k, 1%, 0.063 W, 0402	0402
21	R9	1	1.00k	CRCW04021K00FKED	Vishay-Dale	RES, 1.00 k, 1%, 0.063 W, 0402	0402
22	R10	1	6.04k	CRCW04026K04FKED	Vishay-Dale	RES, 6.04 k, 1%, 0.063 W, 0402	0402
23	R11	1	1.00	CRCW08051R00FKEA	Vishay-Dale	RES, 1.00, 1%, 0.125 W, 0805	0805
24	T1	1	700 uH	G154002LF	GCI Technologies	Transformer, 700 uH, TH	17x16mm
25	TP1	1	White	5012	Keystone	Test Point, Multipurpose, White, TH	White Multipurpose
							Testpoint
26	TP2, TP4	2	Black	5011	Keystone	Test Point, Multipurpose, Black, TH	Black Multipurpose Testpoint
27	TP3	1	Red	5010	Keystone	Test Point, Multipurpose, Red, TH	Red Multipurpose
21	111.3	'	ricu	3010	Neystone	rest rount, multipulpose, Neu, 111	Testpoint
28	U1	1		UCC28700DBV	Texas Instruments	Constant-Voltage, Constant-Current Controller With Primary-Side Regulation, DBV0006A	DBV0006A
29	R12	0	10.0k	CRCW040210K0FKED	Vishay-Dale	RES, 10.0 k, 1%, 0.063 W, 0402	0402

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